



US00D699606S

(12) **United States Design Patent**
Gandhi et al.(10) **Patent No.:** **US D699,606 S**
(45) **Date of Patent:** **** Feb. 18, 2014**(54) **WIRELESS ELECTRONIC PROTOTYPING SYSTEM**6,326,797 B2 * 12/2001 Caggiano et al. 324/719
6,724,207 B1 * 4/2004 Chen 324/756.03
D518,393 S * 4/2006 Nesenoff D10/75
7,859,420 B2 * 12/2010 Hamilton et al. 340/635(71) Applicants: **Gaurav Gandhi**, New Delhi (IN);
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* cited by examiner

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Varun Aggarwal, New Delhi (IN)

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(73) Assignee: **Gaurav Gandhi**, New Delhi (IN)(57) **CLAIM**

The ornamental design for a wireless electronic prototyping system, as shown and described.

(**) Term: **14 Years**(21) Appl. No.: **29/432,738**(22) Filed: **Sep. 20, 2012**(51) LOC (10) Cl. **10-04**

(52) U.S. Cl.

USPC **D10/75**(58) **Field of Classification Search**USPC D10/75, 78; 324/756.01–756.05,
324/763.01–763.02, 517–537, 538–544,
324/555, 556, 156, 713–718, 66; 340/459,
340/635; 714/37, 40, 46, 724, 725, 734,
714/E11.163; 702/118

See application file for complete search history.

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5,684,408 A * 11/1997 King 324/718
D412,294 S * 7/1999 Kaise et al. D10/78**DESCRIPTION**

FIG. 1 is a front elevational view of the wireless electronic prototyping system showing a wireless breadboard.

FIG. 2 is a rear elevational view of the wireless electronic prototyping system showing an outer casing.

FIG. 3 is a left side elevational view of the wireless electronic prototyping system.

FIG. 4 is a right side elevational view of the wireless electronic prototyping system.

FIG. 5 is a top plan view of the wireless electronic prototyping system; and,

FIG. 6 is a bottom plan view of the wireless electronic prototyping system.

The novel design of the wireless electronic prototyping system as described herein allows wireless testing of different electronic circuitry, and is advantageously provided as portable kit that can be accessed via a cloud based application using a mobile communication device or any other communication device.

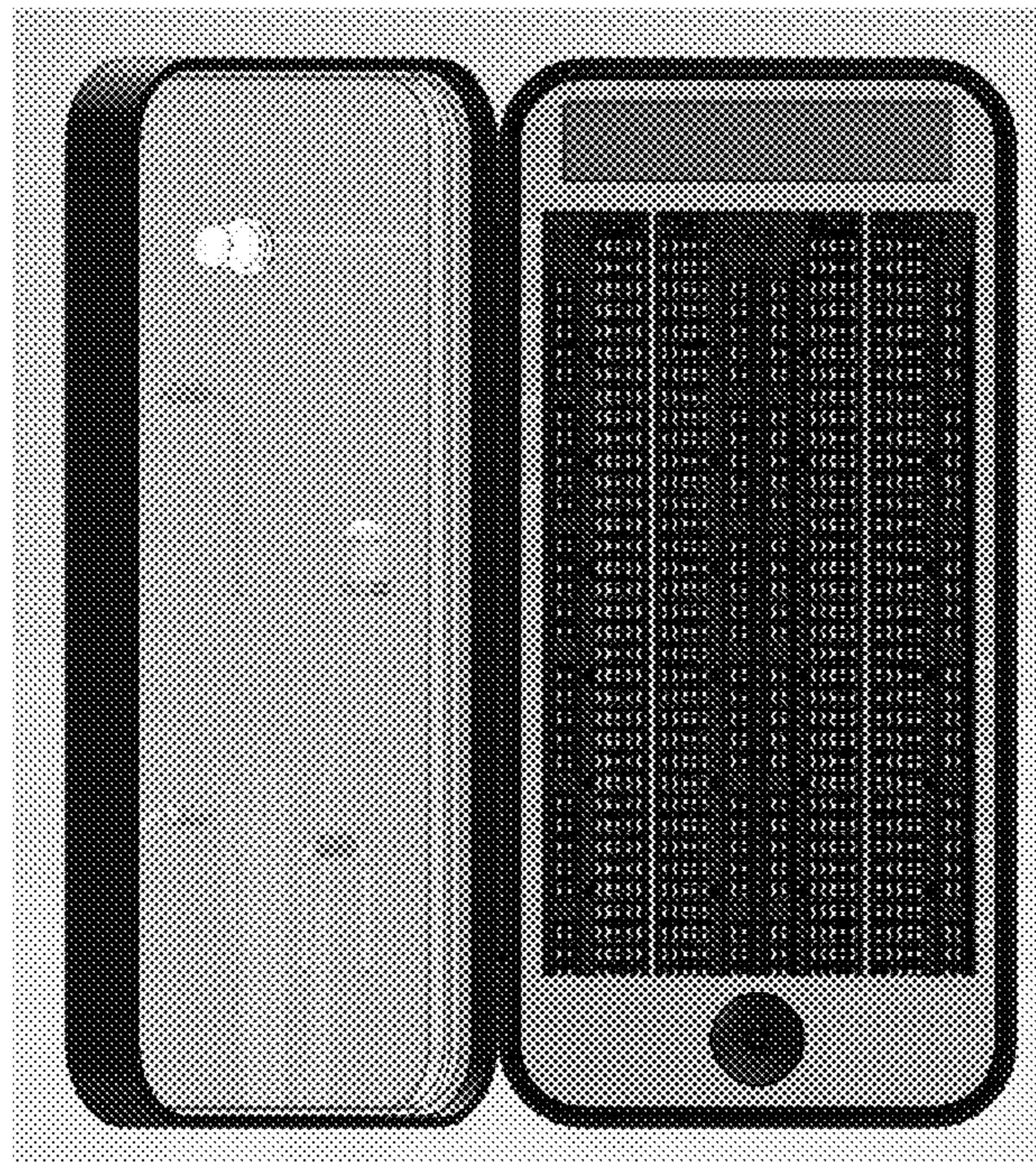
1 Claim, 6 Drawing Sheets



FIG. 1

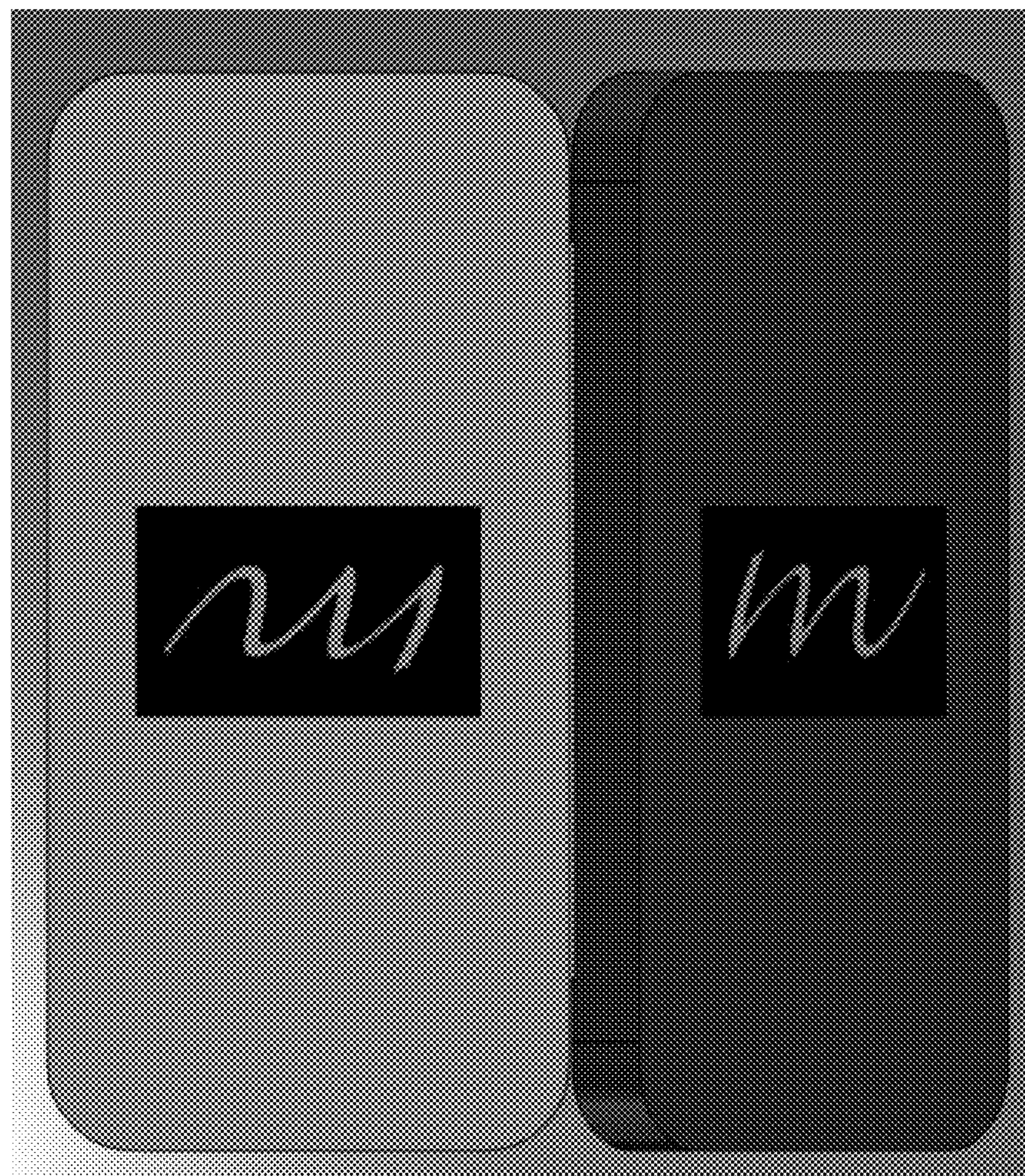


FIG. 2

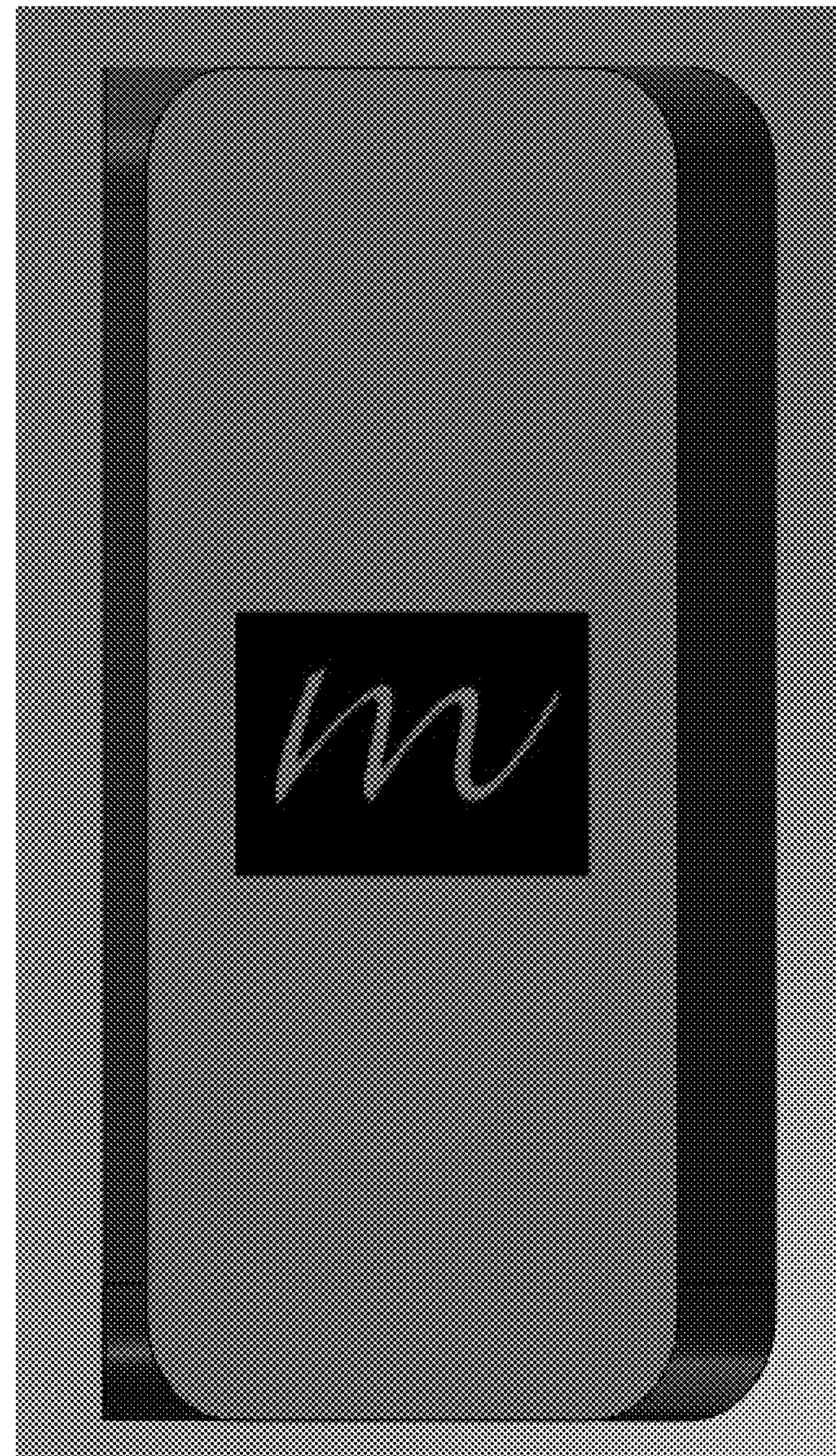


FIG. 3

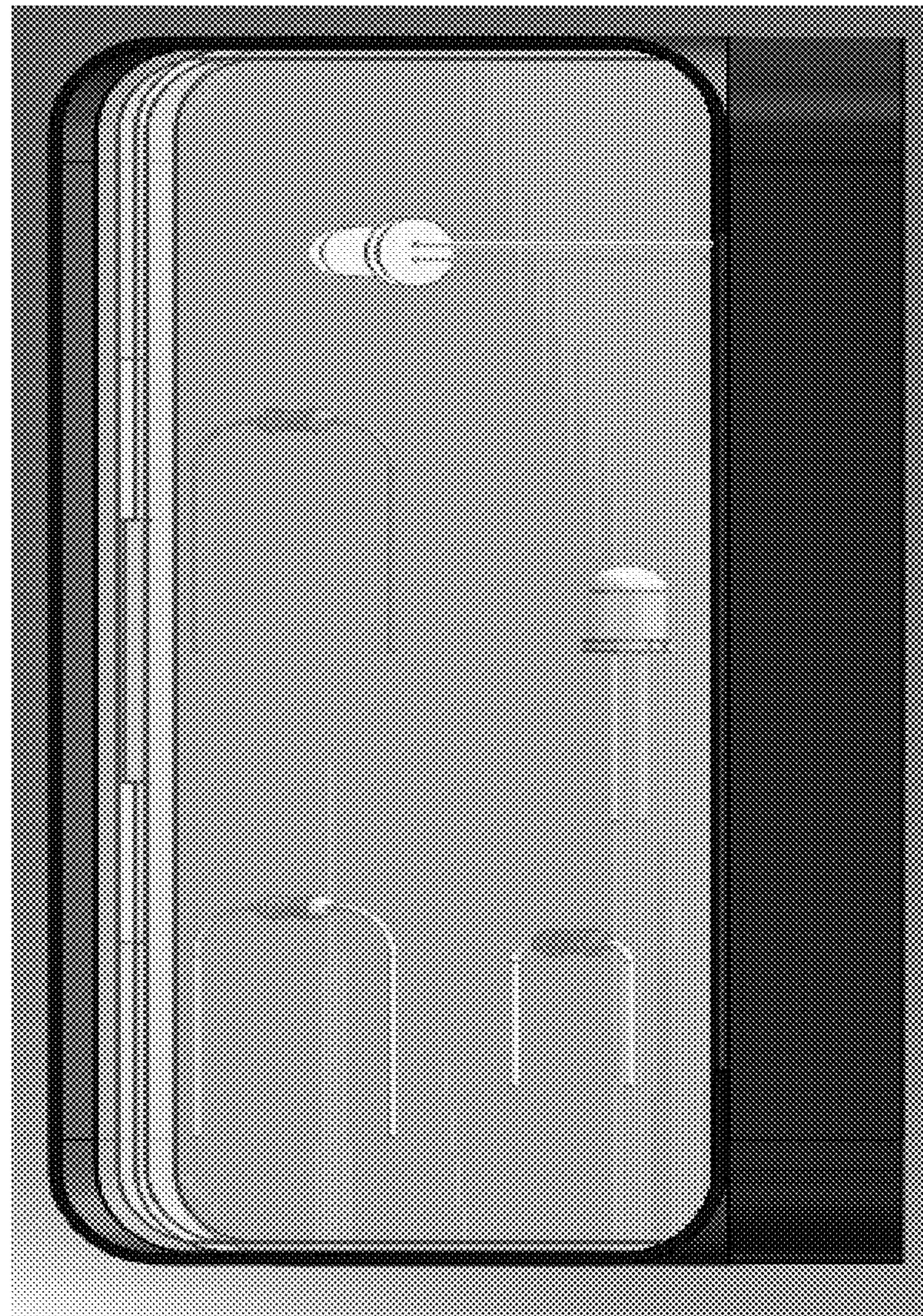


FIG. 4

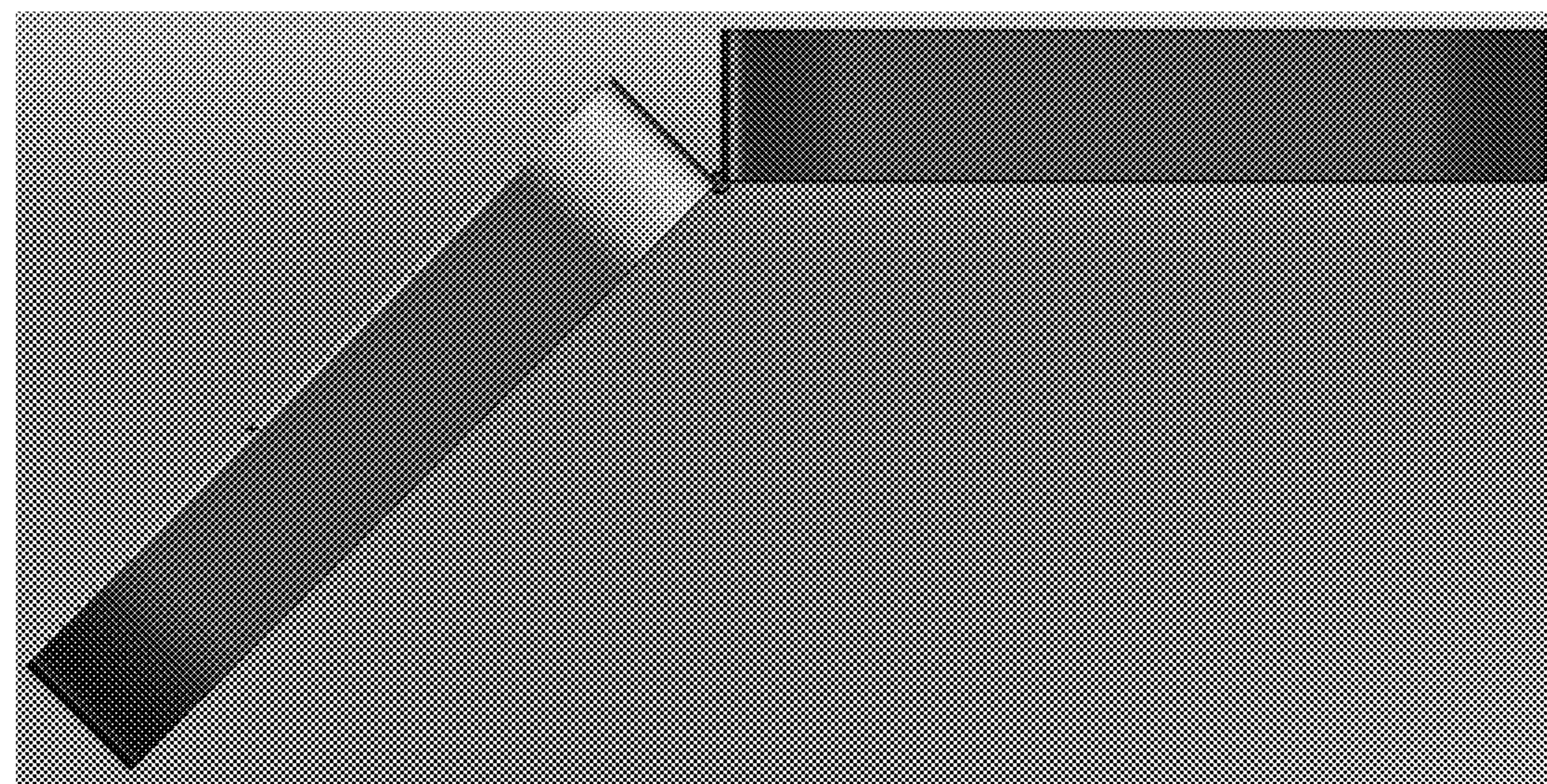


FIG. 5

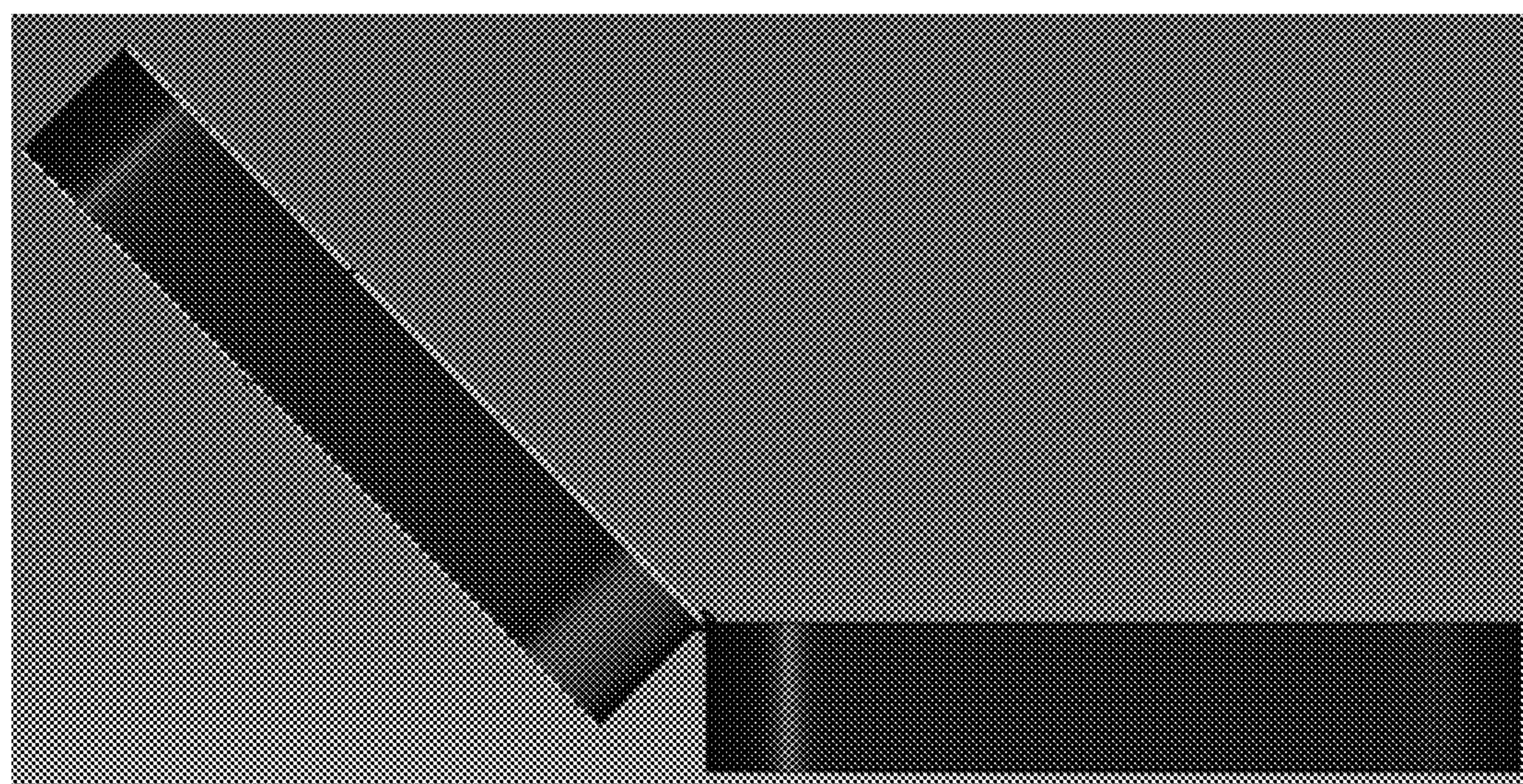


FIG. 6